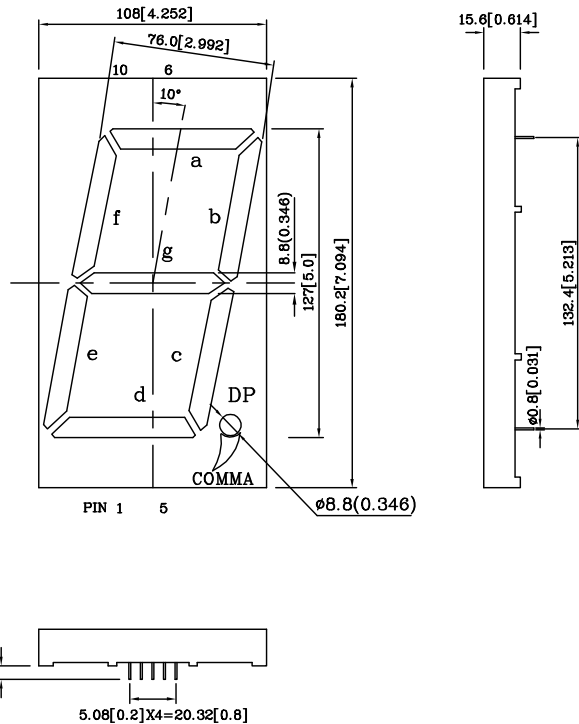
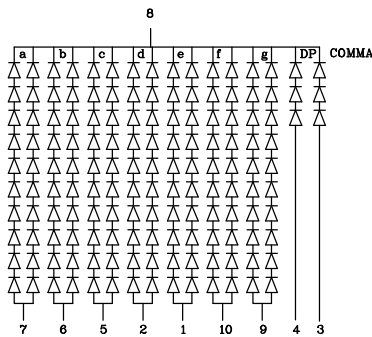


Features

- 5.0 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- I.C. COMPATIBLE.
- CATEGORIZED FOR LUMINOUS INTENSITY.
- MECHANICALLY RUGGED.
- STANDARD : GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.



Notes:

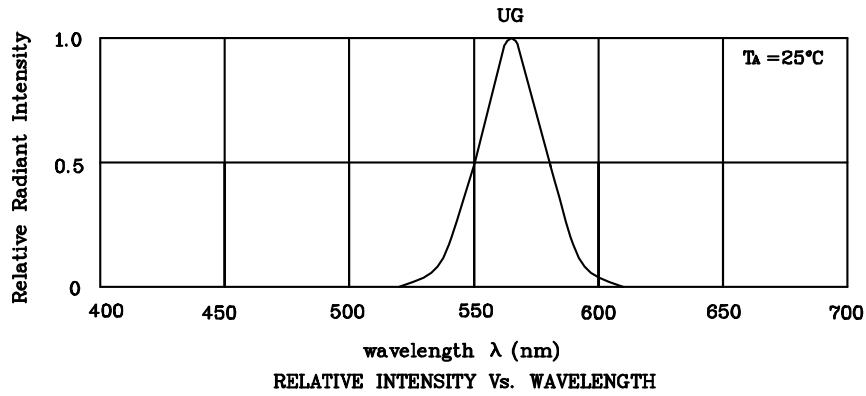
1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.



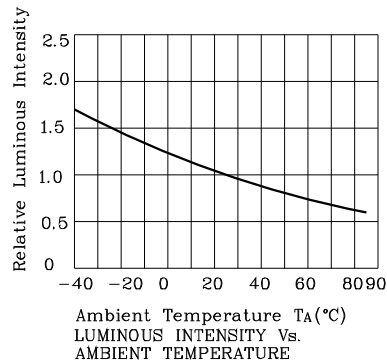
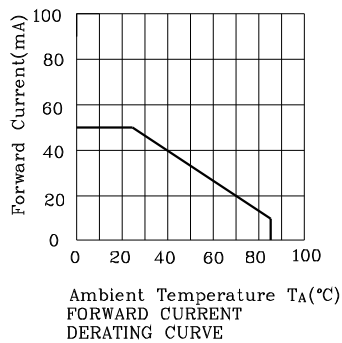
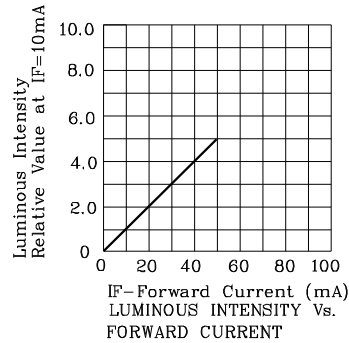
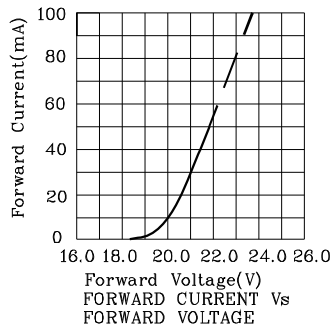
Absolute Maximum Ratings (TA=25°C)		UG (GaP)	Unit
Reverse Voltage Per Segment Or (Dp And Comma)	V _R	50 (15)	V
DC Forward Current Per Segment Or (Dp And Comma)	I _F	50 (25)	mA
Forward Current (Peak) Per Segment Or (Dp And Comma) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	280 (140)	mA
Power Dissipation Per Segment Or (Dp And Comma)	P _T	1250 (187.5)	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds		

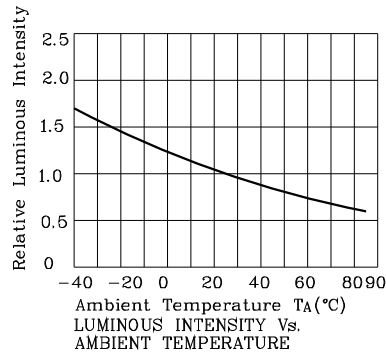
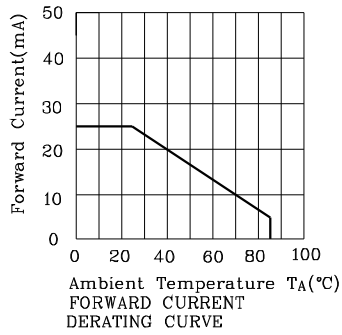
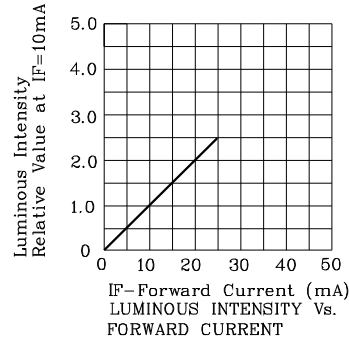
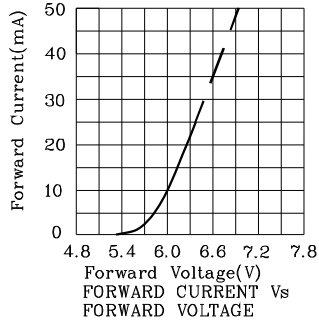
Operating Characteristics (TA=25°C)		UG (GaP)	Unit
Forward Voltage (I _F =10mA) (Typ.) Per Segment Or (Dp And Comma)	V _F	20.0 (6.0)	V
Forward Voltage (I _F =10mA) (Max.) Per Segment Or (Dp And Comma)	V _F	25.0 (7.5)	V
Reverse Current (V _R =50V(15V)) (Max.) Per Segment Or (Dp And Comma)	I _R	20 (10)	μA
Wavelength Of Peak Emission (Typ.) (I _F =10mA)	λ _P	565	nm
Wavelength Of Dominant Emission (Typ.) (I _F =10mA)	λ _D	568	nm
Spectral Line Full Width At Half- Maximum (Typ.) (I _F =10mA)	Δλ	30	nm
Capacitance (Per Segment) (Typ.) (V _F =0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (I _F =10mA) ucd	Wavelength nm λ _P	Description	
			min.	typ.		
XDUG127C-A	Green	GaP	26000	83590	565	Common Cathode, Rt. Hand Decimal
Published Date : JAN 08,2008						
Drawing No : XDSA0156		V6		Checked : Shin Chi		
P.1/5						

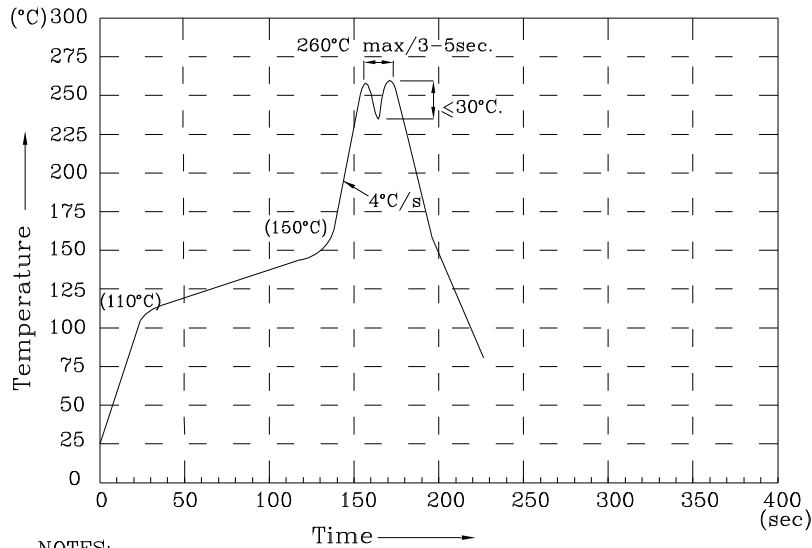


❖ UG





Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.

Remarks:

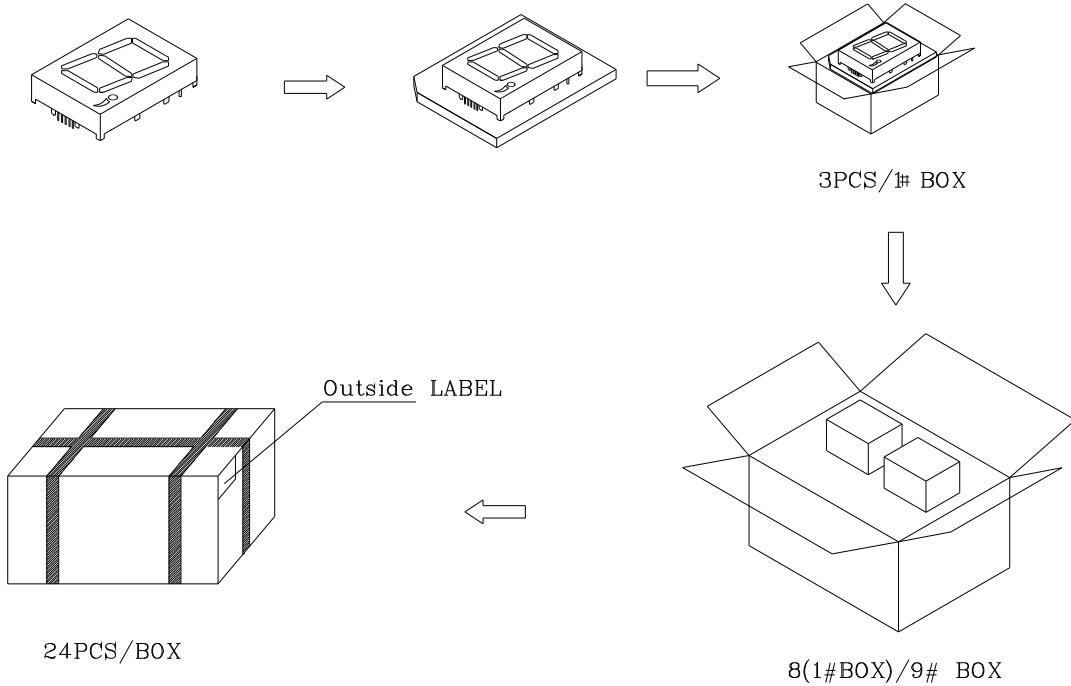
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

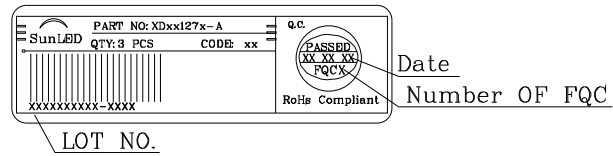
Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

XDUG127C-A



Inside LABEL Paste On The 1# Box



Outside LABEL Paste On The Box

